

### features

- Multi-Rate Operation From 155 Mbps Up To 2.5 Gbps
- Low Power Consumption
- Input Offset Cancellation
- High Input Dynamic Range
- Output Disable
- Output Polarity Select
- CML Data Outputs
- Receive Signal Strength Indicator (RSSI)
- Loss Of Signal Detection (LOS)

- Single 3.3-V Supply
- Surface Mount Small Footprint 3 mm × 3 mm 16-Pin QFN Package

### applications

- SONET/SDH Transmission Systems at OC3, OC12, OC24, OC48
- 1.0625-Gbps and 2.125-Gbps Fibre Channel Receivers
- Gigabit Ethernet Receivers

### description

The ONET2501PA is a versatile high-speed limiting amplifier for multiple fiber optic applications with data rates up to 2.5 Gbps.

This device provides a gain of about 50 dB, which ensures a fully differential output swing for input signals as low as 3 mV<sub>p-p</sub>.

The high input signal dynamic range ensures low jitter output signals even when overdriven with input signal swings as high as 1200 mV<sub>p-p</sub>.

The ONET2501PA is available in a small footprint 3 mm × 3 mm, 16-pin QFN package. The circuit requires a single 3.3-V supply.

This power efficient limiting amplifier is characterized for operation from –40°C to 85°C



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# ONET2501PA 155-Mbps TO 2.5-Gbps LIMITING AMPLIFIER

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## block diagram

A simplified block diagram of the ONET2501PA is shown in Figure 1.

This compact, low power 2.5-Gbps limiting amplifier consists of a high-speed data path with offset cancellation block, a loss of signal and RSSI detection block, and a bandgap voltage reference and bias current generation block.

The limiting amplifier requires a single 3.3-V supply voltage. All circuit parts are described in detail below.

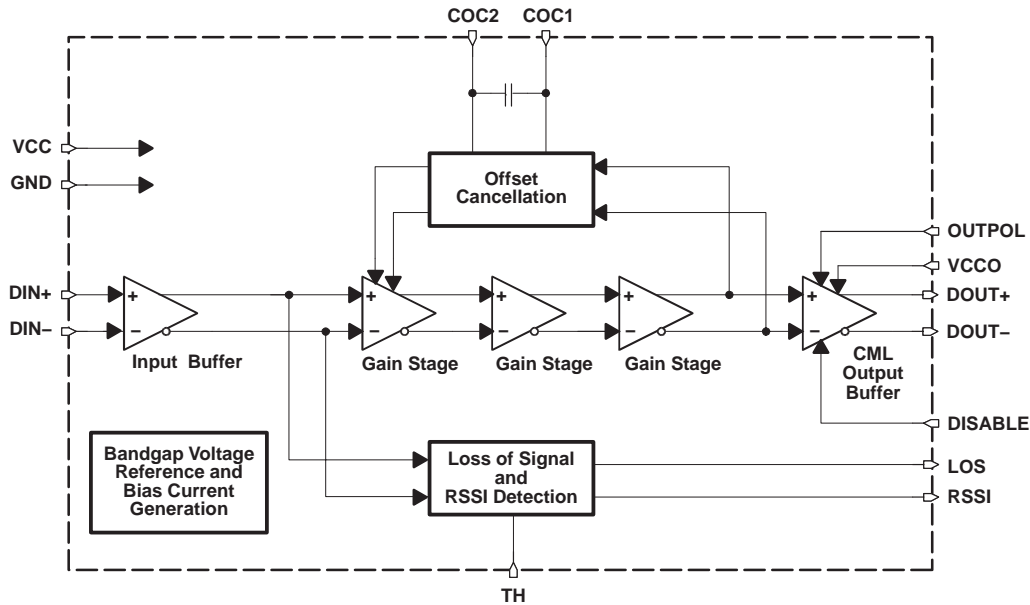


Figure 1. Block Diagram

## high-speed data path

The high-speed data signal is applied to the data path by means of the input signal pins DIN+/DIN-. The data path consists of the input stage with  $2 \times 50\text{-}\Omega$  on-chip line termination to VCC, three gain stages, which provide the required typical gain of about 50 dB, and a CML output stage. The amplified data output signal is available at the output pins DOUT+/DOUT-, which provide  $2 \times 50\text{-}\Omega$  back-termination to VCCO. The output stage also includes a data polarity switching function, which is controlled by the OUTPOL input, and a disable function, controlled by the signal applied to the DISABLE input pin.

An offset cancellation compensates inevitable internal offset voltages and thus ensures proper operation even for small input data signals.

The low frequency cutoff is as low as 45 kHz with the built-in filter capacitor.

For applications, which require even lower cutoff frequencies, an additional external filter capacitor may be connected to the COC1/COC2 pins.

## loss of signal and RSSI detection

The output signal of the input buffer is monitored by the loss of signal and RSSI detection circuitry. In this block a signal is generated, which is linearly proportional to the input amplitude over a wide input voltage range. This signal is available at the RSSI output pin.

Furthermore, this circuit block compares the input signal to a threshold, which can be programmed by means of an external resistor connected to the TH pin. If the input signal falls below the specified threshold, a loss of signal is indicated at the LOS pin.

The relationship between the LOS assert voltage  $V_{AST}$  (in mV<sub>p-p</sub>) and the external resistor  $R_{TH}$  (in k $\Omega$ ) connected to the TH pin can be approximated as given below:

$$R_{TH} = \frac{43 \text{ k}\Omega}{V_{AST}/\text{mV}_{p-p}} - 600 \Omega$$

$$V_{AST} = \frac{43 \text{ mV}_{p-p}}{R_{TH}/\text{k}\Omega + 0.6}$$

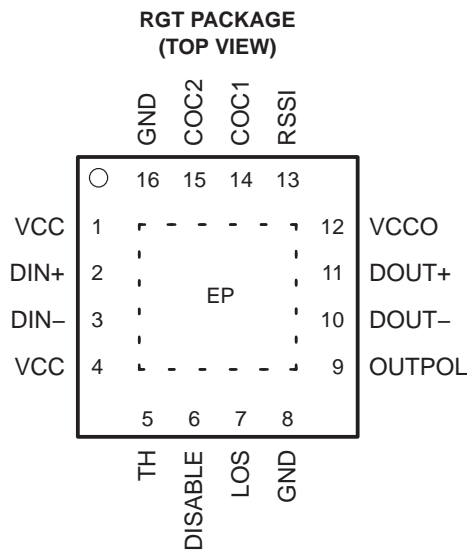
### bandgap voltage and bias generation

The ONET2501PA limiting amplifier is supplied by a single 3.3-V  $\pm 10\%$  supply voltage connected to the VCC and VCCO pins. This voltage is referred to ground (GND).

An on-chip bandgap voltage circuitry generates a supply voltage independent reference from which all other internally required voltages and bias currents are derived.

### package

For the ONET2501PA a small footprint 3 mm  $\times$  3 mm 16-pin QFN package is used, with a lead pitch of 0,5 mm. The pin out is shown in Figure 2.



**Figure 2. Pin Out of ONET2501PA in a 3 mm  $\times$  3 mm 16-Pin QFN Package, Top View**

# ONET2501PA

## 155-Mbps TO 2.5-Gbps LIMITING AMPLIFIER

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### terminal functions

The following table shows a pin description for the ONET2501PA in a 3 mm x 3 mm 16-pin QFN package.

TERMINAL		TYPE	DESCRIPTION
NAME	NO.		
VCC	1, 4	Supply	3.3-V $\pm$ 10% supply voltage
DIN+	2	Analog in	Noninverted data input. On-chip 50- $\Omega$ terminated to VCC.
DIN-	3	Analog in	Inverted data input. On-chip 50- $\Omega$ terminated to VCC.
TH	5	Analog in	LOS threshold adjustment with resistor to GND.
DISABLE	6	CMOS in	Disables CML output stage when set to high level.
LOS	7	CMOS out	High level indicates that the input signal amplitude is below the programmed threshold level.
GND	8, 16, EP	Supply	Circuit ground. Exposed die pad (EP) must be grounded.
OUTPOL	9	CMOS in	Output data signal polarity select (internally pulled up): Setting to high level or leaving pin open selects normal polarity. Low level selects inverted polarity.
DOUT-	10	CML out	Inverted data output. On-chip 50- $\Omega$ back-terminated to VCCO
DOUT+	11	CML out	Noninverted data output. On-chip 50- $\Omega$ back-terminated to VCCO
VCCO	12	Supply	3.3-V $\pm$ 10% supply voltage for output stage
RSSI	13	Analog out	Analog output voltage proportional to the input data amplitude. Indicates the strength of the received signal (RSSI).
COC1	14	Analog	Offset cancellation filter capacitor terminal 1. Connect an additional filter capacitor between this pin and COC2 (pin 15). To disable the offset cancellation loop connect COC1 and COC2 (pins 14 and 15).
COC2	15	Analog	Offset cancellation filter capacitor terminal 2. Connect an additional filter capacitor between this pin and COC1 (pin 14). To disable the offset cancellation loop connect COC1 and COC2 (pins 14 and 15).

### absolute maximum ratings

over operating free-air temperature range unless otherwise noted<sup>†</sup>

		VALUE	UNIT
VCC, VCCO	Supply voltage, See Note 1	-0.3 to 4	V
VDIN+, VDIN-	Voltage at DIN+, DIN-, See Note 1	0.5 to 4	V
VTH, DISABLE, LOS, OUTPOL, DOUT+, DOUT-, RSSI, COC1, and COC2	Voltage at TH, DISABLE, LOS, OUTPOL, DOUT+, DOUT-, RSSI, COC1, and COC2, See Note 1	-0.3 to 4	V
VCOC,DIFF	Differential voltage between COC1 and COC2	$\pm$ 1	V
VDIN,DIFF	Differential voltage between DIN+ and DIN-	$\pm$ 2.5	V
ILOS	Current into LOS	-1 to 9	mA
IDIN+, IDIN-, IDOUT+, IDOUT-	Continuous current at inputs and outputs	-25 to 25	mA
ESD	ESD rating at all pins	3	kV (HBM)
TJ(max)	Maximum junction temperature	125	°C
Tstg	Storage temperature range	-65 to 85	°C
TA	Characterized free-air operating temperature range	-40 to 85	°C
TL	Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260	°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network ground terminal.



# ONET2501PA

## 155-Mbps TO 2.5-Gbps LIMITING AMPLIFIER

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### recommended operating conditions

	MIN	TYP	MAX	UNIT
Supply voltage, $V_{CC}$ , $V_{CCO}$	3	3.3	3.6	V
Operating free-air temperature, $T_A$	-40		85	°C

### dc electrical characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CC}, V_{CCO}$ Supply voltage		3	3.3	3.6	V
$I_{CC}$ Supply current	DISABLE = low (excludes CML output current)		32	40	mA
$V_{OD}$ Differential data output voltage swing	DISABLE = high		0.25	10	mV <sub>p-p</sub>
	DISABLE = low	600	780	1200	mV <sub>p-p</sub>
$r_{IN}, r_{OUT}$ Data input/output resistance	Single ended		50		Ω
RSSI output voltage	Input = 2 mV <sub>p-p</sub> , $R_{RSSI} \geq 10 \text{ k}\Omega$		100		mV
	Input = 80 mV <sub>p-p</sub> , $R_{RSSI} \geq 10 \text{ k}\Omega$		2800		
RSSI linearity	20-dB input signal, $V_{IN} \leq 80 \text{ mVpp}$		±3%	±8%	
$V_{(IN\_MIN)}$ Data input sensitivity	BER < $10^{-10}$		3	5	mV <sub>p-p</sub>
$V_{(IN\_MAX)}$ Data input overload		1200			mV <sub>p-p</sub>
CMOS input high voltage		2.1			V
CMOS input low voltage				0.6	V
LOS high voltage	$I_{SINK} = -30 \mu\text{A}$	2.4			V
LOS low voltage	$I_{SOURCE} = 1 \text{ mA}$			0.8	V
LOS hysteresis	$2^{23}-1$ PRBS (at 2.5 Gbps and 155 Mbps)	2.5	4.5		dB
$V_{AST}$ LOS assert threshold range	$2^{23}-1$ PRBS (at 2.5 Gbps and 155 Mbps)		5-40		mV <sub>p-p</sub>
PSNR Power supply noise rejection	$f < 2 \text{ MHz}$	26			dB

### ac electrical characteristics

over recommended operating conditions (unless otherwise noted) typical operating condition is at  $V_{CC} = 3.3 \text{ V}$  and  $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Low frequency -3-dB bandwidth	$C_{OC} = \text{open}$		45	70	kHz
	$C_{OC} = 100 \text{ nF}$		0.8		
Data rate		2.5			Gb/s
$V_{NI}$ Input referred noise				300	$\mu\text{VRMS}$
DJ Deterministic jitter, See Note 2	K28.5 pattern at 2.5 Gbps		8.5	25	ps <sub>p-p</sub>
	$2^{23}-1$ PRBS equivalent pattern at 2.5 Gbps		9.3	30	
	$2^{23}-1$ PRBS equivalent pattern at 155 Mbps		25	50	
RJ Random jitter	Input = 5 mVpp		6.5		ps <sub>RMS</sub>
	Input = 10 mVpp		3		
$t_r$ Output rise time	20% to 80%		60	85	ps
$t_f$ Output fall time	20% to 80%		60	85	ps
$t_{DIS}$ Disable response time			20		ns
$t_{LOS}$ LOS assert/deassert time		2		100	$\mu\text{s}$

NOTE 2: Deterministic jitter does not include pulse-width distortion due to residual small output offset voltage.



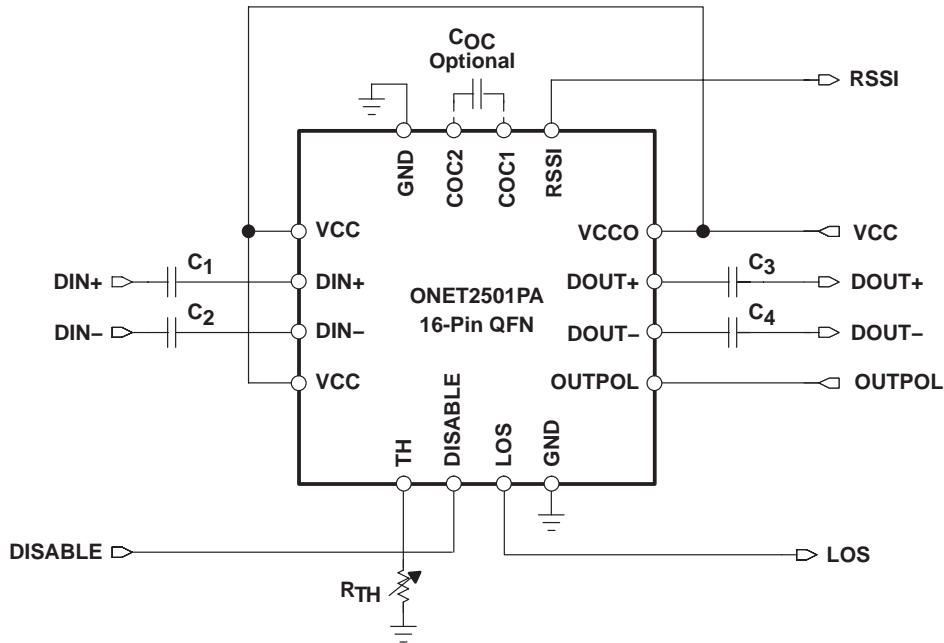
**ONET2501PA**  
**155-Mbps TO 2.5-Gbps LIMITING AMPLIFIER**

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**APPLICATION INFORMATION**

Figure 3 shows the ONET2501PA connected with an ac-coupled interface to the data signal source as well as to the output load.

Besides the ac-coupling capacitors  $C_1$  through  $C_4$  in the input and output data signal lines, the only required external component is the LOS threshold setting resistor  $R_{TH}$ . In addition, an optional external filter capacitor ( $C_{OC}$ ) may be used if a lower cutoff frequency is desired.



**Figure 3. Basic Application Circuit With AC-Coupled I/Os**

**TYPICAL CHARACTERISTICS**

Typical operating condition is at  $V_{CC} = V_{CCO} = 3.3\text{ V}$  and  $T_A = 25^\circ\text{C}$ , unless otherwise noted

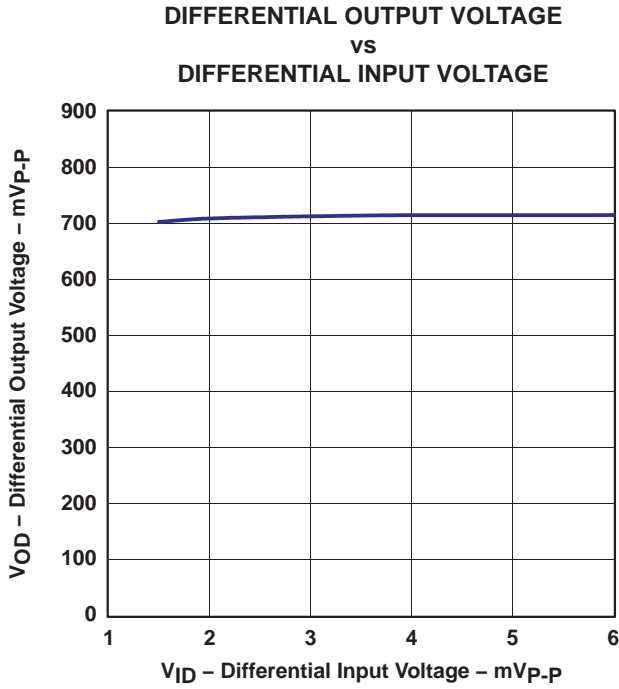


Figure 4

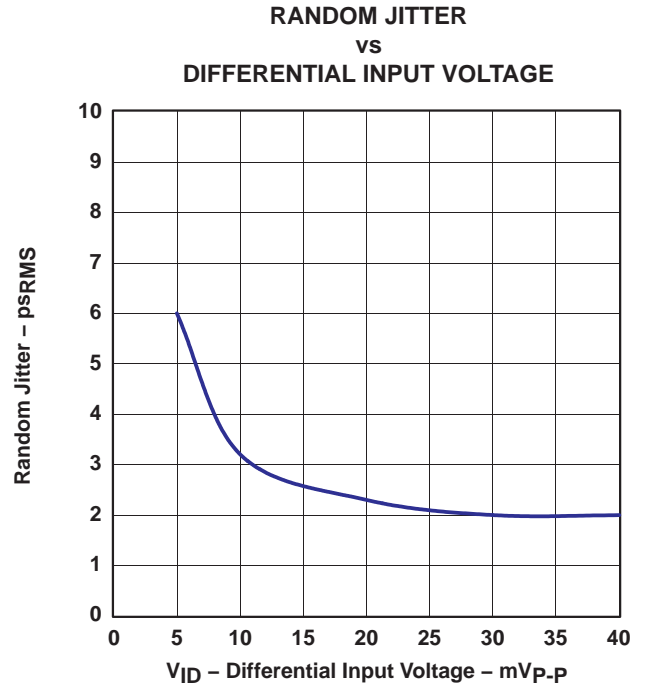


Figure 5

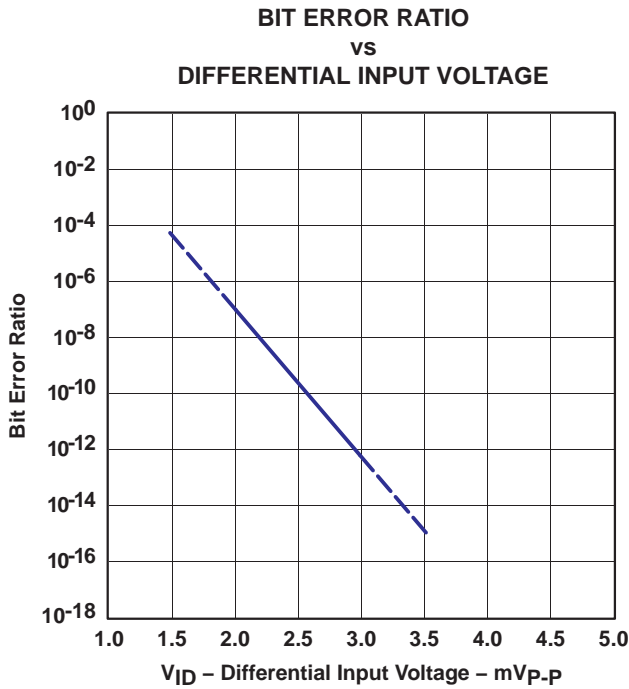


Figure 6

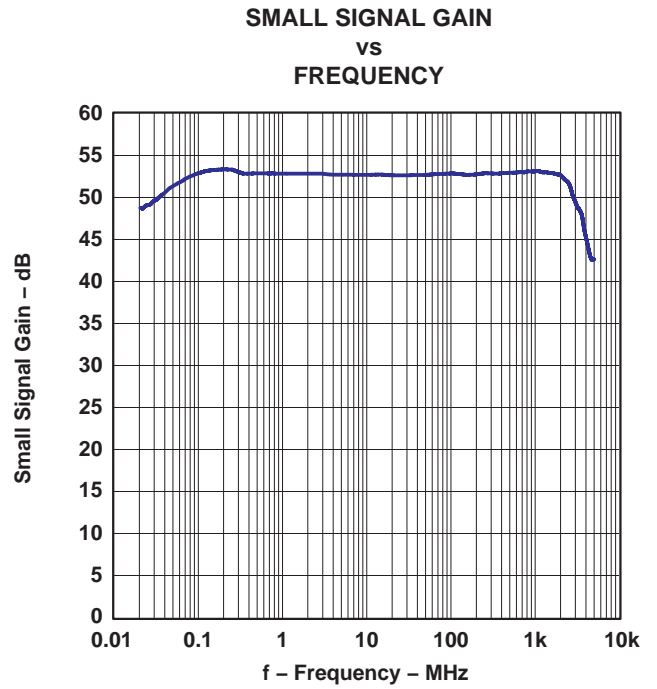
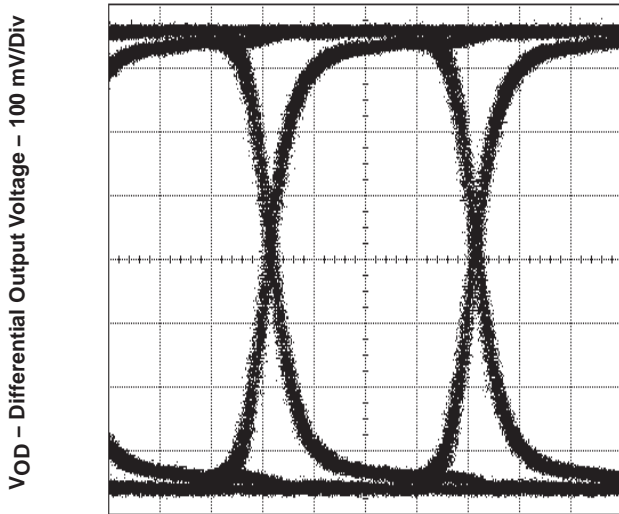


Figure 7

**TYPICAL CHARACTERISTICS**

Typical operating condition is at  $V_{CC} = V_{CCO} = 3.3\text{ V}$  and  $T_A = 25^\circ\text{C}$ , unless otherwise noted

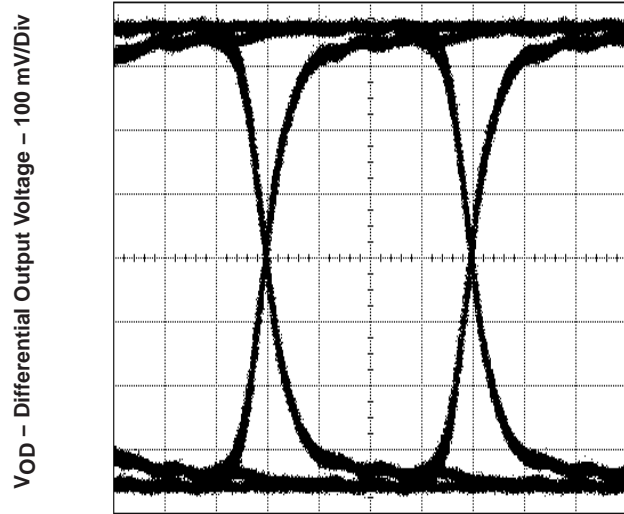
**OUTPUT EYE-DIAGRAM at 2.5 GBPS  
 and MINIMUM INPUT VOLTAGE (5 mV<sub>pp</sub>)**



t - Time - 100 ps/Div

**Figure 8**

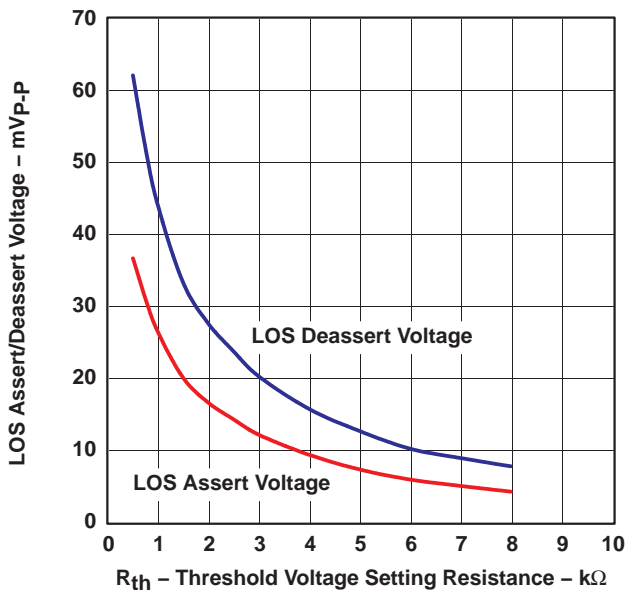
**OUTPUT EYE-DIAGRAM at 2.5 GBPS  
 and MAXIMUM INPUT VOLTAGE (1200 mV<sub>pp</sub>)**



t - Time - 100 ps/Div

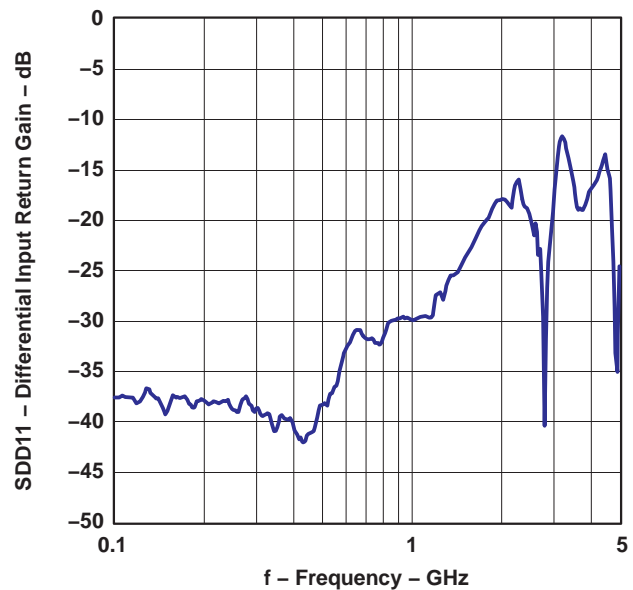
**Figure 9**

**LOS ASSERT/DEASSERT VOLTAGE  
 VS  
 THRESHOLD VOLTAGE SETTING RESISTANCE**



**Figure 10**

**DIFFERENTIAL INPUT RETURN GAIN  
 VS  
 FREQUENCY**

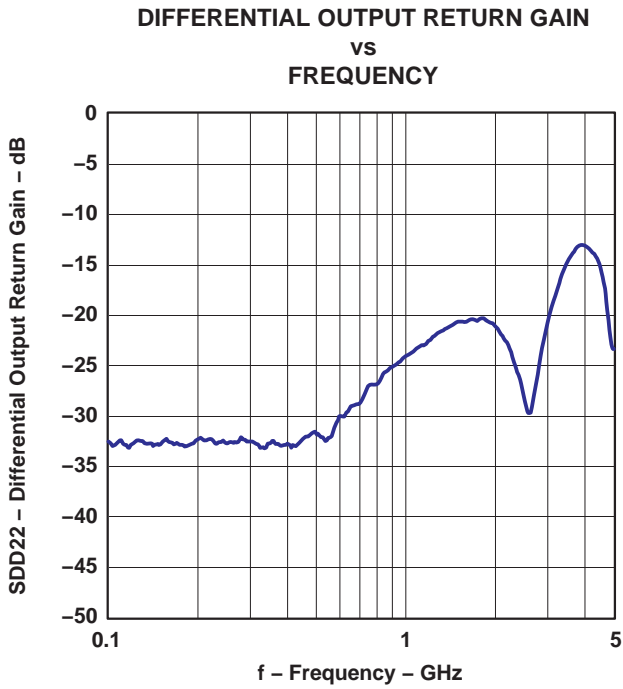


**Figure 11**

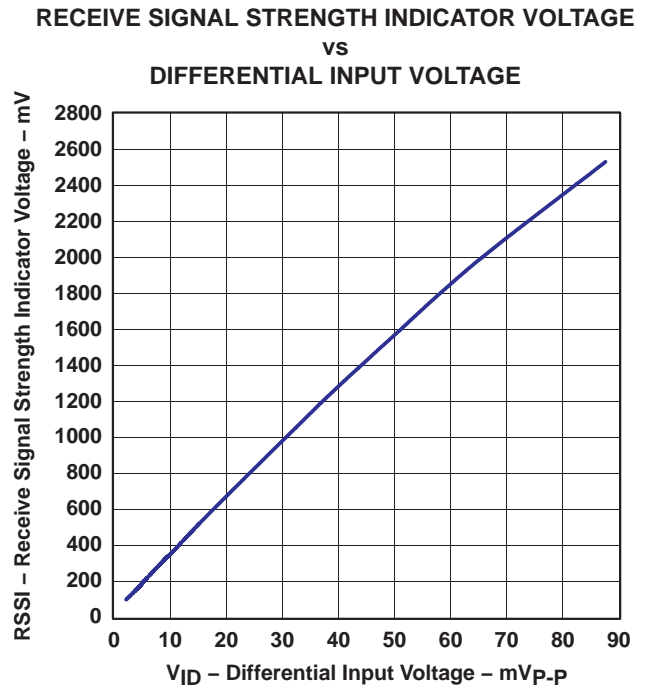


**TYPICAL CHARACTERISTICS**

Typical operating condition is at  $V_{CC} = V_{CCO} = 3.3\text{ V}$  and  $T_A = 25^\circ\text{C}$ , unless otherwise noted



**Figure 12**



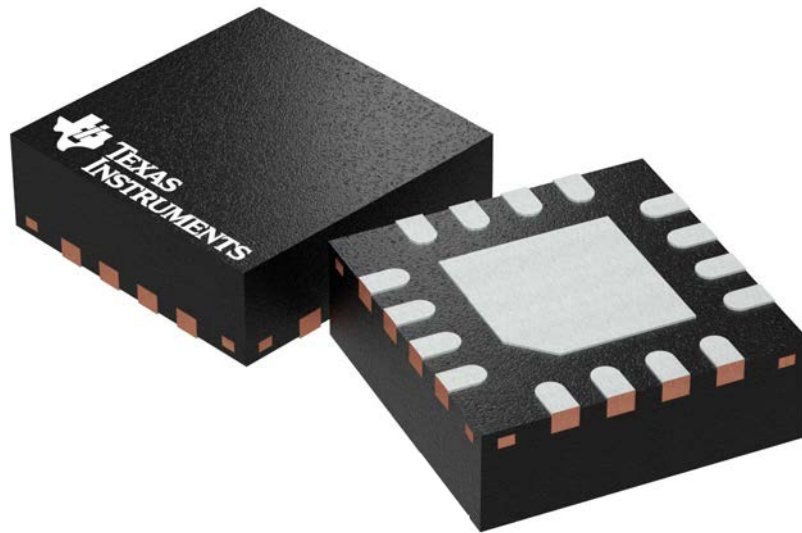
**Figure 13**

**RGT 16**

**GENERIC PACKAGE VIEW**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

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